

Spezifikationen	
Artikelnummer	XC7K325T-3FFG900E
Hersteller	Xilinx
Beschreibung	IC FPGA 500 I/O 900FCBGA
Kategorie	Integrierte Schaltungen (ICs) > Eingebettete - FPGAs
Teilstatus	1342 pcs Stock
Spannungsversorgung	0.97 V ~ 1.03 V
Gesamt-RAM-Bits	16404480
Supplier Device-Gehäuse	900-FCBGA (31x31)
Serie	Kintex®-7
Verpackung / Gehäuse	900-BBGA, FCBGA
Betriebstemperatur	0°C ~ 100°C (TJ)
Anzahl der Logikelemente / Zellen	326080
Anzahl der LABs / CLBs	25475
Anzahl der E / A	500
Befestigungsart	Surface Mount

sein:

XC7K325T-3FFG900C
XILINX
XILINX New

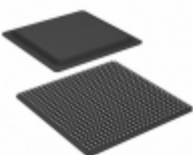
 **XILINX**
ALL PROGRAMMABLE.

XC7K325T-3FFG676C
XILINX
XILINX New



XC7K325T-3FBG900E
Xilinx Inc.
IC FPGA 500 I/O 900FCBGA


XC7K325T-3FFG676I
XILINX
XC7K325T-3FFG676I XILINX



XC7K325T-L2FBG676I
Xilinx Inc.
IC FPGA 400 I/O 676FCBGA



The image displays a Xilinx XC7K325T-3FFG900I BGA package, which is a square integrated circuit with numerous pins. The package is shown from a top-down perspective, highlighting its square shape and the dense array of pins. The Xilinx logo, consisting of the letters 'XC' in a stylized, interconnected font, is prominently displayed in the center of the package. Below the logo, the text 'XC7K325T-3FFG900I' is printed in a bold, sans-serif font. Further down, the text 'XILINX' and 'XILINX BGA' are printed in a smaller, sans-serif font. The entire package is set against a plain white background.

Mehr

Xilinx	XC7K325T-3FFG900E Datenblatt	XC7K325T-3FFG900E-Datenblätter	XC7K325T-3FFG900E PDF	Xilinx XC7K325T-3FFG900E
XC7K325T-3FFG900E Electronic	XC7K325T-3FFG900E-Komponenten	XC7K325T-3FFG900E-Verteiler	XC7K325T-3FFG900E-Bild	XC7K325T-3FFG900E-Teil
XC7K325T-3FFG900E Preis	XC7K325T-3FFG900E Hersteller	XC7K325T-3FFG900E Bild	XC7K325T-3FFG900E Aktie	XC7K325T-3FFG900E Inventar
XC7K325T-3FFG900E Neu	XC7K325T-3FFG900E Original	XC7K325T-3FFG900E garantiert	XC7K325T-3FFG900E RFQ	XC7K325T-3FFG900E Online bestellen